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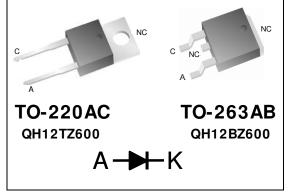
QH12TZ600, QH12BZ600 Qspeed[™] Family

600 V, 12 A H-Series PFC Diode

Product Summary

I _{F(AVG)}	12	А
V _{RRM}	600	V
Q _{RR} (Typ at 125 °C)	30	nC
I _{RRM} (Typ at 125 °C)	2.2	А
Softness t _B /t _A (Typ at 125 °C)	0.65	





RoHS Compliant

Package uses Lead-free plating and Green mold compound. Halogen free per IEC 61249-2-21.

General Description

This device has the lowest Q_{RR} of any 600 V silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

Applications

- Power Factor Correction (PFC) boost diode
- Motor drive circuits
- DC-AC inverters

Features

- Low Q_{RR}, low I_{RRM}, low t_{RR}
- High dl_F/dt capable (1000 A / μs)
- Soft recovery

Benefits

- Increases efficiency
 - Eliminates need for snubber circuits
 - Reduces EMI filter component size & count
- Enables extremely fast switching

Absolute Maximum Ratings

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

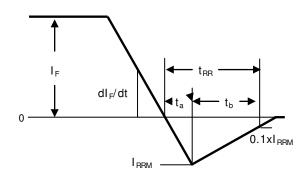
Symbol	Parameter	Conditions	Rating	Units
V _{RRM}	Peak repetitive reverse voltage	$T_J = 25 °C$	600	V
I _{F(AVG)}	Average forward current	$T_J = 150 \ ^{\circ}C, \ T_C = 90 \ ^{\circ}C$	12	А
I _{FSM}	Non-repetitive peak surge current	60 Hz, $\frac{1}{2}$ cycle, T _C = 25 °C	100	А
I _{FSM}	Non-repetitive peak surge current	$^{1\!\!/_2}$ cycle of t = 28 μs Sinusoid, T_C = 25 °C	350	А
TJ	Operating junction temperature range		-55 to 150	°C
T _{STG}	Storage temperature		-55 to 150	°C
	Lead soldering temperature	Leads at 1.6 mm from case, 10 sec	300	°C
VISOL	Isolation voltage (leads-to-tab)	AC, TO-220	2500	V
VISOL	Isolation voltage (leads-to-tab)	AC, TO-263	1500	V
P _D	Power dissipation	$T_{\rm C} = 25 ^{\circ}{\rm C}$	61	W

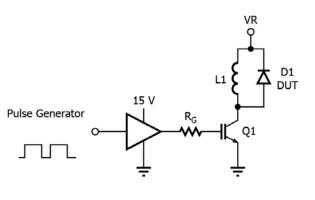
Thermal Resistance							
Symbol	Resistance from:	Conditions	Rating	Units			
$R_{\theta JA}$	Junction to ambient	TO-220 (only)	62	°C/W			
$R_{ ext{ heta}JC}$	Junction to case		2.05	°C/W			

Electrical Specifications at T_J= 25 °C (unless otherwise specified)

Symbol	Parameter	Conditions	М	in	Тур	Max	Units
DC Chara	DC Characteristics						-
	Deveree everent	$V_{R} = 600 \text{ V}, \text{ T}_{J} = 25 \text{ °C}$	<u>}</u>	-	-	250	μA
I _R	Reverse current	$V_{R} = 600 \text{ V}, \text{ T}_{J} = 125 ^{\circ}$	С	-	0.6	-	mA
		$I_F = 12 \text{ A}, T_J = 25 \text{ °C}$		-	2.65	3.1	V
V _F	Forward voltage	$I_F = 12 \text{ A}, T_J = 150 ^{\circ}\text{C}$		-	2.33	-	V
CJ	Junction capacitance	$V_{R} = 10 V, 1 MHz$	V _R = 10 V, 1 MHz			-	рF
Dynamic	Characteristics						
		$dI/dt = 200 A/\mu s$	T _J = 25 °C	-	11.6	-	ns
t _{RR}	Reverse recovery time	V_{R} = 400 V, I_{F} = 12 A	T _J = 125 °C	-	20.5	-	ns
0	Devenue an environmente an	dI/dt = 200 A/µs	T _J = 25 °C	-	9.2	14	nC
Q _{RR}	Reverse recovery charge	V_{R} = 400 V, I_{F} = 12 A	T _J = 125 °C	-	30	-	nC
	Maximum reverse	dI/dt = 200 A/µs	T _J = 25 °C	-	1.27	1.8	А
I _{RRM}	recovery current	V_{R} = 400 V, I_{F} = 12 A	T _J = 125 °C	-	2.2	-	А
	Cottanon fortun t _B	dl/dt = 200 A/µs	$T_J = 25 °C$	-	0.6	-	
S Softness factor = $\frac{t_B}{t_A}$	$V_{\rm R} = 400 \text{ V}, I_{\rm F} = 12 \text{ A}$	T _J = 125 °C	-	0.65	-		

Note to component engineers: H-Series diodes employ Schottky technologies in their design and construction. Therefore, Component Engineers should plan their test setups to be similar to those for traditional Schottky test setups. (For additional details, see Application Note AN-300.)





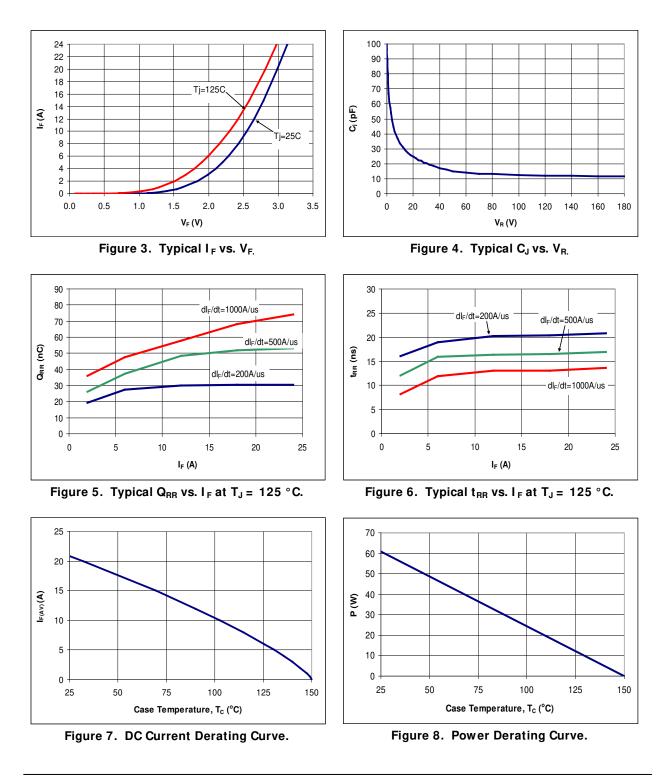
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Figure 1. Reverse Recovery Definitions.

Figure 2. Reverse Recovery Test Circuit.







Electrical Specifications at T_J= 25 °C (unless otherwise specified)

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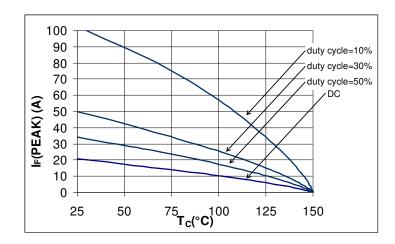


Figure 9. $I_F(PEAK)$ vs. T_C , f = 70 kHz.

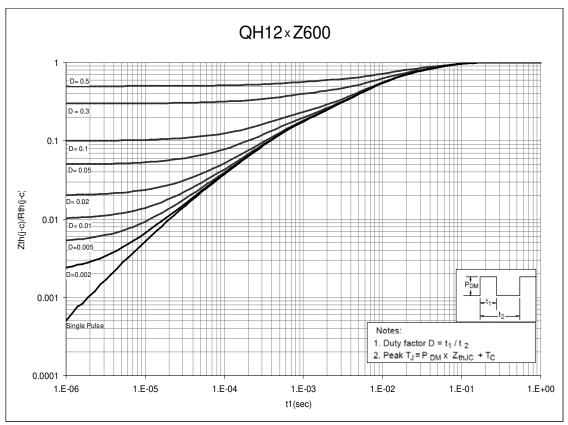


Figure 10. Normalized Maximum Transient Thermal Impedance.





Dimensional Outline Drawings

TO-220AC

	Millimeters			
Dim	MIN	МАХ		
Α	4.32	4.70		
A1	1.14	1.40		
A2	2.03	2.79		
С	0.34	0.610		
D	9.65	10.67		
Е	2.49	2.59		
E1	4.98	5.18		
F	0.508	1.016		
F1	1.14	1.78		
н	14.71	16.51		
H1	5.84	6.795		
H2	8.40	9.00		
H3	3.53	3.96		
H4	2.54	3.05		
L	12.70	14.22		
L1	-	6.35		

Mechanical Mounting Method	Maximum Torque / Pressure specification	
Screw through hole in package tab	1 Newton Meter (nm) or 8.8 inch-pounds (lb-in)	
Clamp against package body	12.3 kilogram-force per square centimeter (kgf/cm ²) or 175 lbf/in ²	

Soldering time and temperature: This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

Ordering Information

Part Number	Package	Packing
QH12TZ600	TO-220AC	50 units/tube

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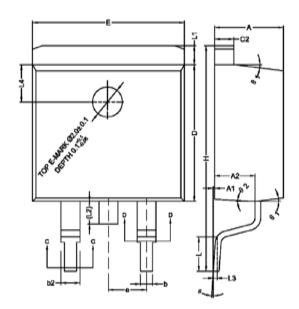




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Dimensional Outline Drawings

TO-263AB

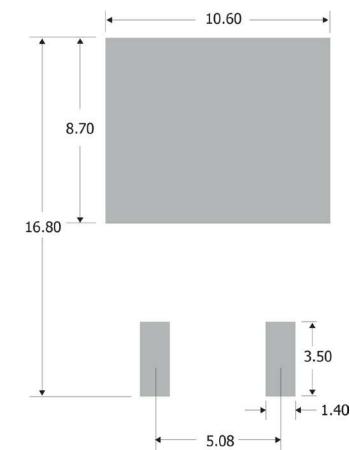


	Millimeters		
Dim	MIN	МАХ	
Α	4.40	4.70	
A1	0.00	0.25	
A2	2.59	2.79	
b	0.77	0.90	
b2	1.23	1.36	
c2	1.22	1.32	
D	9.05	9.25	
E	10.06	10.26	
e	2.54 BSC	2.54 BSC	
Н	14.70	15.50	
L	2.00	2.60	
L1	1.17	1.40	
L2	-	1.75	
L3	0.25 BSC	0.25 BSC	
L4	2.00 BSC	2.00 BSC	
Θ	0°	8°	
01	5°	9°	
Θ2	1°	5°	





Footprint and Solder Pad Dimensions



Pad Dimensions in mm: TO-263AB

Soldering time and temperature: This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

Ordering Information

Part Number	Package	Packing
QH12BZ600	TO-263AB	800 units/reel

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QH12TZ600, QH12BZ600

Revision	Notes	Date
1.0	Released by Qspeed	12/09
1.1	Converted to Power Integrations Document	01/11
1.2	Added QH12BZ600	02/13
1.3	Updated with new Brand Style.	06/15
1.4	Added footprint and solder pad dimension for TO-263AB package.	11/15





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